

Legislation Details (With Text)

File #: BILL NO. 23-212
Name:
Type: Ordinance
Status: Passed
File created: 10/19/2023
In control: City Council - Regular Session
On agenda: 11/7/2023
Final action: 11/21/2023
Title: An Ordinance accepting Final Plat entitled, "Woodland Oaks, Lots 1-42 and Tracts A & B", as a subdivision to the City of Lee's Summit, Missouri.
 (Note: First read by Council on November 7, 2023. Passed by unanimous vote.)

Sponsors:

Indexes:

Code sections:

Attachments: 1. Ordinance, 2. Supporting Document: PC Action Letter, 3. Supporting Document: Final Plat, 4. Supporting Document: Location Map, 5. Supporting Document - LOC

| Date | Ver. | Action By | Action | Result |
|------------|------|--------------------------------|----------------------------|--------|
| 11/21/2023 | 1 | City Council - Regular Session | adopted and numbered | Pass |
| 11/7/2023 | 1 | City Council - Regular Session | advanced to second reading | Pass |
| 10/26/2023 | 1 | Planning Commission | recommended for approval | Pass |

An Ordinance accepting Final Plat entitled, "Woodland Oaks, Lots 1-42 and Tracts A & B", as a subdivision to the City of Lee's Summit, Missouri.

(Note: First read by Council on November 7, 2023. Passed by unanimous vote.)

Issue/Request:

The applicant proposes a final plat composed of forty-two (42) lots and two (2) common area tracts on 19.18 acres. The proposed final plat is consistent with the approved preliminary development plan (Appl. #PL2019-330) for the single-family residential on the subject property.

Proposed Council Motion:

I move for second reading of an Ordinance accepting Final Plat entitled, "Woodland Oaks, Lots 1-42 and Tracts A & B", as a subdivision to the City of Lee's Summit, Missouri.

Dawn Bell, Planning Manager

On a motion by Vice Chair Arth, seconded by Ms. Rader, the Planning Commission unanimously voted on October 26, 2023, to approve the Consent Agenda, inclusive of Appl. #PL2021-072 - FINAL PLAT - Woodland Oaks, Lots 1 thru 42 and Tracts A & B; Engineering Solutions, applicant.